



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: Robert J. Small; Maria Peterson; Tuan Truong; Melvin Keith Carter;  
and Lily Yao  
Assignee: EKC Technology, Inc.  
Title: Compositions For Chemical Mechanical Planarization Of Copper  
Serial No.: 10/017,934 Filed: December 12, 2001  
Examiner: Unknown Group Art Unit: 1765  
Docket No.: M-11675 US

San Francisco, California  
March 7, 2002

**NOTICE OF CHANGE OF ADDRESS**

COMMISSIONER FOR PATENTS  
Washington, D. C. 20231

Sir:

Please direct all correspondence in the above-identified application and with respect  
to any patent that issues on this application to the undersigned at this address:

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In addition, please use Customer Number 27869, which replaces Customer Number  
24251 on the enclosed Declaration:



**27869**

PATENT TRADEMARK OFFICE

**EXPRESS MAIL LABEL NO.:**

**EL 896829544 US**

Respectfully submitted,

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